

**IN THE UNITED STATES DISTRICT COURT
FOR THE DISTRICT OF DELAWARE**

ELM 3DS INNOVATIONS, LLC,

Plaintiff,

v.

MICRON TECHNOLOGY, INC., MICRON
SEMICONDUCTOR PRODUCTS, INC., and
MICRON CONSUMER PRODUCTS
GROUP, INC.,

Defendants.

C.A. No. 14-1431-LPS-CJB

ELM 3DS INNOVATIONS, LLC,

Plaintiff,

v.

SAMSUNG ELECTRONICS CO., LTD.,
SAMSUNG SEMICONDUCTOR, INC.,
SAMSUNG ELECTRONICS AMERICA,
INC., and SAMSUNG AUSTIN
SEMICONDUCTOR,
LLC,

Defendants.

C.A. No. 14-1430-LPS-CJB

ELM 3DS INNOVATIONS, LLC,

Plaintiff,

v.

SK HYNIX INC., SK HYNIX AMERICA
INC., HYNIX SEMICONDUCTOR
MANUFACTURING AMERICA INC., and
SK HYNIX MEMORY SOLUTIONS
INC.,

Defendants.

C.A. No. 14-1432-LPS-CJB

**STIPULATION AND [PROPOSED] ORDER REGARDING CLAIM CONSTRUCTION
BRIEFING AND HEARING**

WHEREAS, Plaintiff Elm 3DS Innovations, LLC (“Plaintiff”) petitioned the Court of Appeals for the Federal Circuit for rehearing on a claim term at issue in these actions;

WHEREAS, Defendants Micron Technology, Inc., Micron Semiconductor Products, Inc., Micron Consumer Products Group, Inc., Samsung Electronics Co., Ltd., Samsung Semiconductor, Inc., Samsung Electronics America, Inc., Samsung Austin Semiconductors, LLC, SK Hynix Inc., SK Hynix America Inc., Hynix Semiconductor Manufacturing America Inc., and SK Hynix Memory Solutions Inc. (“Defendants”) requested that the Plaintiff agree to postpone the claim construction briefing schedule and hearing until a decision on the petition for rehearing is issued by the Court of Appeals for the Federal Circuit;

WHEREAS, the parties have agreed to the following modifications to the claim construction briefing schedule entered by Your Honor on July 12, 2019 (D.I. 191)¹;

IT IS HEREBY STIPULATED, subject to order of the Court, that the claim construction briefing and hearing schedule is modified as follows;

Deadline	Current Date	New Date
Revised Opening Claim Construction Briefs	July 26, 2019	September 9, 2019
Answering Claim Construction Briefs	August 23, 2019	October 7, 2019
Joint Claim Construction Brief	August 30, 2019	October 14, 2019
Markman Hearing	September 13, 2019	October 28, 2019 at _____ (or at the Court’s convenience)

*November 15, 2019
at 4:00 p.m.*

¹ All D.I. numbers refer to C.A. No. 14-1431-LPS-CJB

/s/ Brian E. Farnan

Brian E. Farnan (#4089)
Michael J. Farnan (#5165)
Farnan LLP
919 North Market Street
12th Floor
Wilmington, DE 19801
(302) 777-0300
bfarnan@farnanlaw.com
mfarnan@farnanlaw.com

Attorneys for Plaintiff Elm 3DS Innovations, LLC

/s/ Pilar G. Kraman

Adam W. Poff (#3990)
Pilar G. Kraman (#5199)
Young Conaway Stargatt & Taylor, LLP
Rodney Square
1000 North King Street
Wilmington, DE 19801
Telephone: (302) 571-6600
apoff@ycst.com
pkraman@ycst.com

Attorneys For Defendants Samsung Electronics Co., Ltd., Samsung Semiconductor, Inc., Samsung Electronics America, Inc., and Samsung Austin Semiconductor, LLC

/s/ Frederick L. Cottrell, III

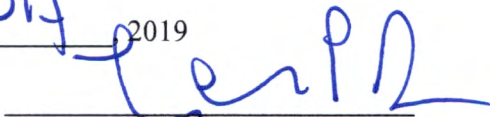
Frederick L. Cottrell, III (#2555)
Travis S. Hunter (#5350)
Tyler E. Cragg (#6398)
Richards Layton & Finger
One Rodney Square
920 North King Street
Wilmington, DE 19801
(302) 651-7836
cottrell@rlf.com
hunter@rlf.com
cragg@rlf.com

Attorneys for Defendants Micron Technology, Inc., Micron Semiconductor Products, Inc. and Micron Consumer Products Group, Inc.

/s/ Daniel M. Silver

Daniel M. Silver (#4758)
Benjamin A. Smyth (#5528)
McCarter & English, LLP
Renaissance Center
405 N. King Street, 8th Floor
Wilmington, DE 19801
(302) 984-6300
dsilver@mccarter.com
bsmyth@mccarter.com

Attorneys for Defendants SK Hynix Inc., SK Hynix America Inc., Hynix Semiconductor Manufacturing America Inc., and SK Hynix Memory Solutions Inc.,

IT IS SO ORDERED this 24th day of July, 2019


Honorable Leonard P. Stark